MASS PORTAL MP1200 CRAIG

Solution for large part production



KEY FEATURES

- "Single-click" workflow
- Automatic bed leveling •
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 Integrated dual filament dryer
 Nozzle: Ø0.4mm Brass
 Duild en extruder
- Open material
- Large build area •
- Up to 5 kg spools •
- Dual printhead
- Liquid cooling

- HARDWARE
- All metal hotend
- Bowden extruder
- Build area: ø540mm x 580mm
- Integrated dryers: 1 (dual)
- Part cooling fans: 2
- Detachable Bowden assembly
- Modular design

SOFTWARE

- At least 16Gb memory card installed
- Integrated slicing and g-code processing
- Web workflow and machine management system

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MASS PORTAL

MP1200 CRAIG

Printer specification

Printer

Technology: Fused Filament Fabrication (FFF) Build volume (d x h): 540mm x 580 mm, cylindric Motion system: precision linear guideways Maximum printhead travel speed: 150 mm/s XYZ accuracy: 6, 6, 5 micron Ultimate layer resolution: 50 micron Electronics: 32-bit Firmware: open-source Repetier-Firmware Connectivity: USB 2.0 and Ethernet jacks, Wi-Fi Automation ready: yes (software interfaces)

Chamber

Build chamber: enclosed; Heated up to 80C Build chamber door: tempered glass Build chamber illumination: yes

Build plate

Type: glass plate Temperature up to 120 °C Heatup time: 5 min

Filament dryers

Compatibility: "open material" spools up to 5 kg Spool size (diameter x width): 350 mm x 100 mm

Power requirements

Installed power 4000W

Regulatory compliance

Safety Overheating protection: yes

Printer size Dimensions (w x d x h): 740 mm x 845 mm x 2030 mm

Ambient conditions

Operating ambient temperature: 15-35 °C, 10-90 % RH

Software

Supplied software: Mass Portal Cloud (printing, drying profile management software) Mass Portal Cloud Embedded (device control software) Supported 3D models file format : .stl, .obj, .3mf Supported print file format: .gcode (up to 150MB)

EXTRUSION SYSTEM

Pro Bowden 1.75

- Up to 450 °C
- Dual Nozzle Bowden
- Fan part cooling
- Liquid cooled
- Automatic bed leveling
- Detachable assembly